
HN27C4001G Series

524288-word × 8-bit CMOS UV Erasable and Programmable ROM

HITACHI

Description

The Hitachi HN27C4001G is a 4-Mbit ultraviolet erasable and electrically programmable ROM, featuring high speed and low power dissipation. Fabricated on advanced fine process and high speed circuitry technique, the HN27C4001G makes high speed access time possible. Therefore, it is suitable for high speed microcomputer systems. The HN27C4001G offers high speed programming using page programming mode.

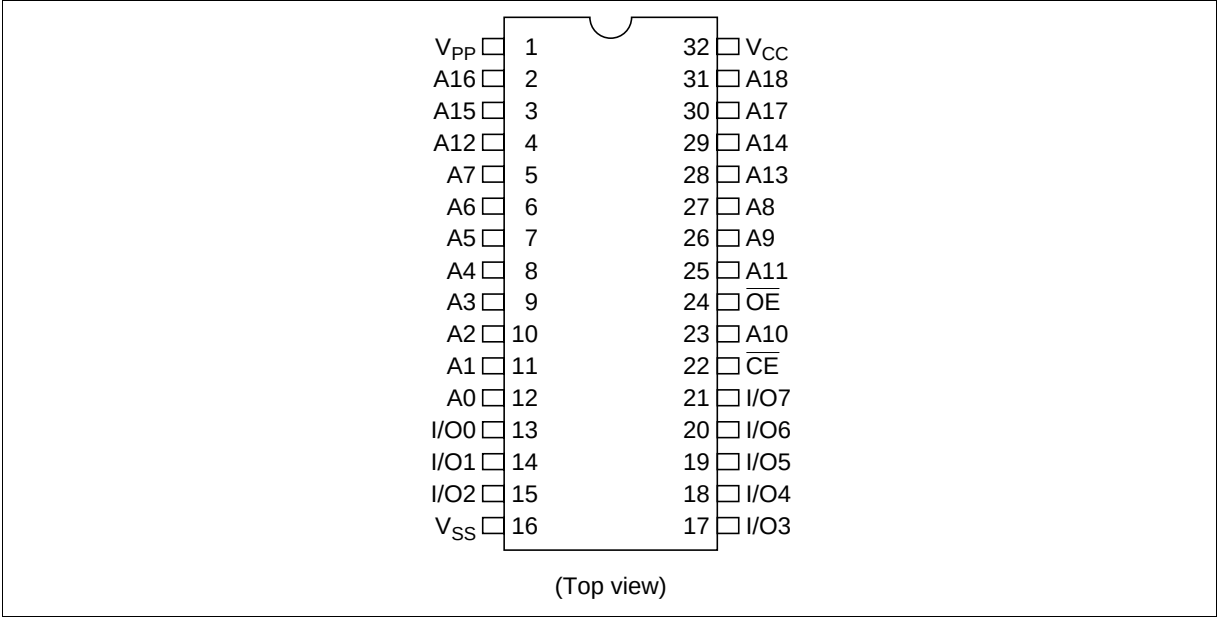
Features

- High speed
Access time: 100 ns/120 ns/150 ns (max)
- Low power dissipation
Standby mode: 5 μW(typ)
Active mode: 35 mW/MHz (typ)
- Fast high reliability page programming and fast high-reliability programming
Programming voltage: +12.5 V D.C.
Program time: 3.5 sec (min) (Theoretical in page programming)
- Inputs and outputs TTL compatible during both read and program modes
- Pin arrangement
32-pin JEDEC standard
- Device identifier mode
Manufacturer code and device code

Ordering Information

Type No.	Access Time	Package
HN27C4001G-10	100 ns	600 mil 32-pin Cerdip (DG-32A)
HN27C4001G-12	120 ns	
HN27C4001G-15	150 ns	

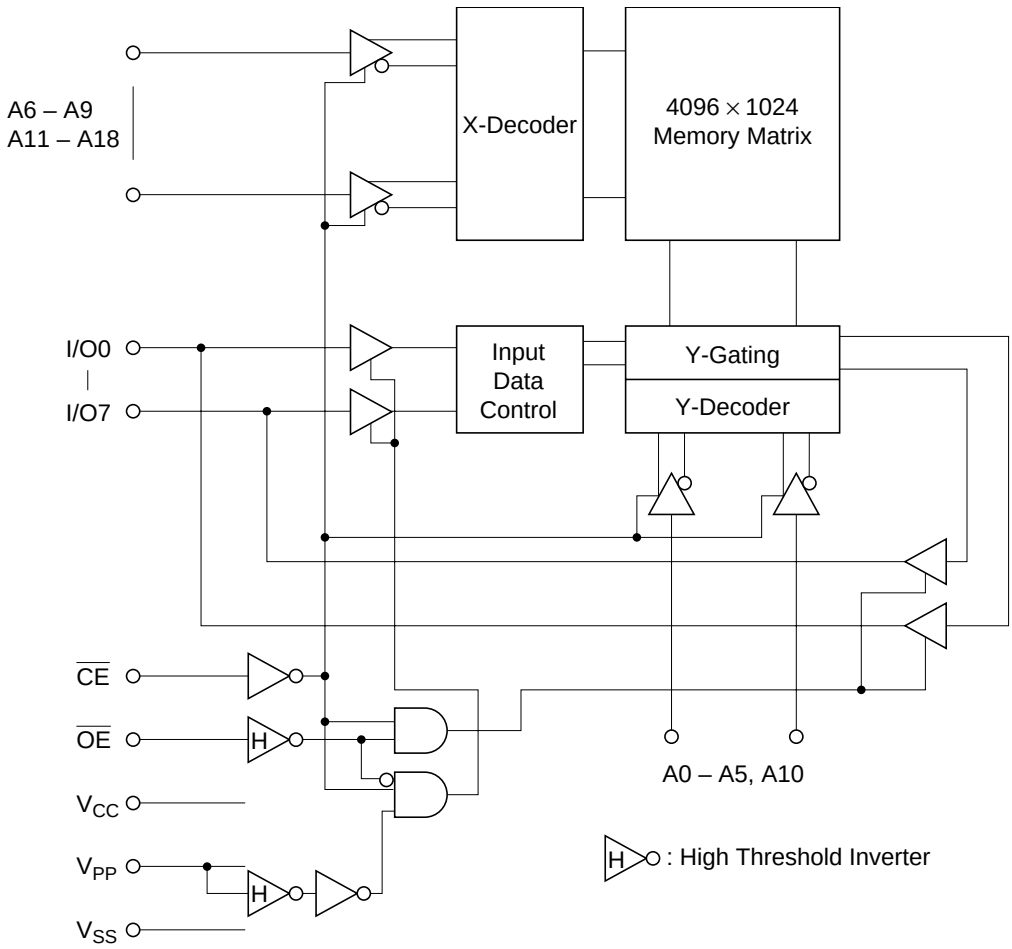
Pin Arrangement



Pin Description

Pin Name	Function
A0–A18	Address
I/O0 – I/O7	Input / output
$\overline{\text{CE}}$	Chip enable
$\overline{\text{OE}}$	Output enable
V _{CC}	Power supply
V _{PP}	Programming power supply
V _{SS}	Ground

Block Diagram



Mode Selection

Mode	Pin	$\overline{CE}$ (22)	$\overline{OE}$ (24)	A9 (26)	V_{PP} (1)	V_{CC} (32)	I/O (13 – 15, 17 – 21)
Read		V_{IL}	V_{IL}	X	$V_{SS} - V_{CC}$	V_{CC}	Dout
Output disable		V_{IL}	V_{IH}	X	$V_{SS} - V_{CC}$	V_{CC}	High-Z
Standby		V_{IH}	X	X	$V_{SS} - V_{CC}$	V_{CC}	High-Z
Page program	Page program set	V_{IH}	V_H^{*2}	X	V_{PP}	V_{CC}	High-Z
	Page data latch	V_{IL}	V_H^{*2}	X	V_{PP}	V_{CC}	Din
	Page program	V_{IL}	V_{IH}	X	V_{PP}	V_{CC}	High-Z
	Page program verify	V_{IH}	V_{IL}	X	V_{PP}	V_{CC}	Dout
	Page program reset	V_{IH}	V_{IH}	X	V_{CC}	V_{CC}	High-Z
Word program	Program	V_{IL}	V_{IH}	X	V_{PP}	V_{CC}	Din
	Program verify	V_{IH}	V_{IL}	X	V_{PP}	V_{CC}	Dout
	Optional verify	V_{IL}	V_{IL}	X	V_{PP}	V_{CC}	Dout
	Program inhibit	V_{IH}	V_{IH}	X	V_{PP}	V_{CC}	High-Z
Identifier		V_{IL}	V_{IL}	V_H^{*2}	$V_{SS} - V_{CC}$	V_{CC}	Code

Notes: 1. X: Don't care.
2. V_H : 12.0 V $\pm$ 0.5 V.

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
All input and output voltages ^{*1}	Vin, Vout	−0.6 ^{*2} to +7.0	V
Voltage on Pin A9 and $\overline{OE}$	V_{ID}	−0.6 ^{*2} to +13.0	V
Vpp voltage ^{*1}	V_{PP}	−0.6 to +13.5	V
Vcc voltage ^{*1}	V_{CC}	−0.6 to +7.0	V
Operating temperature range	Topr	0 to +70	°C
Storage temperature range ^{*3}	Tstg	−65 to +125	°C
Storage temperature range under bias	Tbias	−20 to +80	°C

Notes: 1. Relative to V_{SS} .
2. Vin, Vout, V_{ID} min = −2.0 V for pulse width $\leq$ 20 ns.
3. Storage temperature range of device before programming.

Capacitance (Ta = 25°C, f = 1 MHz)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Input capacitance	Cin	—	—	12	pF	Vin = 0 V
Output capacitance	Cout	—	—	20	pF	Vout = 0 V

Read Operation

DC Characteristics (VCC = 5 V ± 10%, Vpp = VSS to VCC, Ta = 0 to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Input leakage current	ILi	—	—	2	μA	Vin = 5.5 V
Output leakage current	ILO	—	—	2	μA	Vout = 5.5 V/0.45 V
Vpp current	IPp1	—	1	20	μA	Vpp = 5.5 V
Standby VCC current	ISB1	—	—	1	mA	$\overline{CE} = V_{IH}$
	ISB2	—	1	20	μA	$\overline{CE} = V_{CC} \pm 0.3 V$
Operating VCC current	ICC1	—	—	30	mA	Iout = 0 mA, f = 1 MHz
	ICC2	—	—	100	mA	Iout = 0 mA, f = 10 MHz
Input voltage	VIL	−0.3 ¹	—	0.8	V	
	VIH	2.2	—	VCC + 1 ²	V	
Output voltage	VOL	—	—	0.45	V	IOL = 2.1 mA
	VOH	2.4	—	—	V	IOL = −400 μA

Notes: 1. VIL min = −1.0 V for pulse width ≤ 50 ns.
VIL min = −2.0 V for pulse width ≤ 20 ns.
2. VIH max = VCC + 1.5 V for pulse width ≤ 20 ns.
If VIH is over the specified maximum value, read operation cannot be guaranteed.

HN27C4001G Series

AC Characteristics ($V_{CC} = 5\text{ V} \pm 10\%$, $V_{PP} = V_{SS}$ to V_{CC} , $T_a = 0$ to $+70^{\circ}\text{C}$)

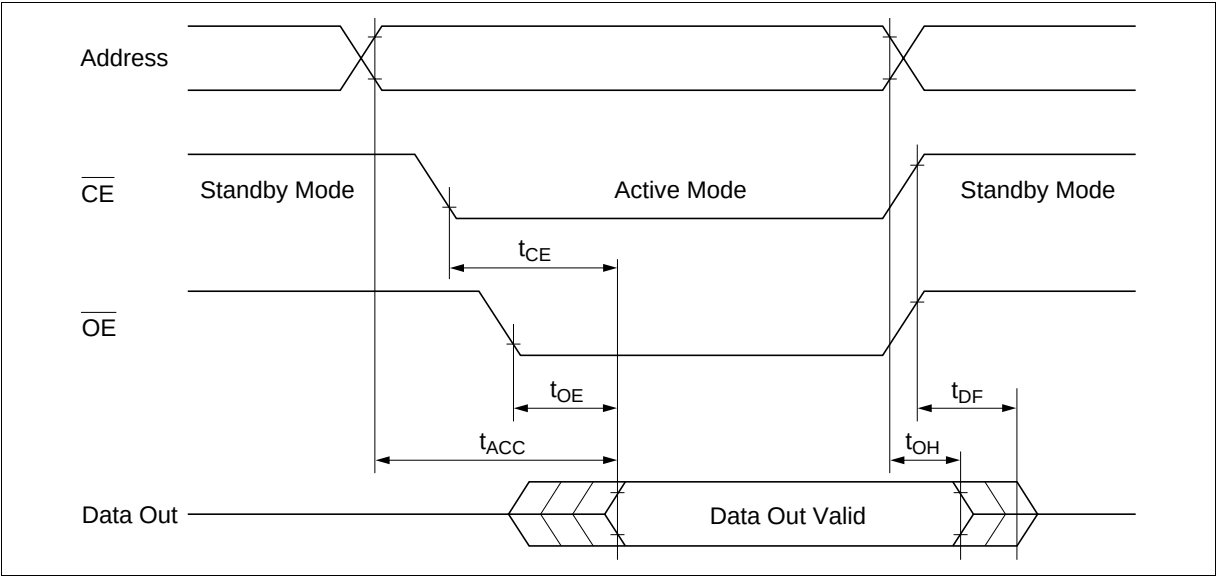
Test Conditions

- Input pulse levels: 0.45 to 2.4 V
- Input rise and fall time: $\leq 10\text{ ns}$
- Output load: 1TTL Gate + 100 pF
- Reference levels for measuring timing: 0.8 V, 2.0 V

		HN27C4001							
		-10		-12		-15			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Test Conditions
Address to output delay	t _{ACC}	—	100	—	120	—	150	ns	$\overline{CE} = \overline{OE} = V_{IL}$
$\overline{CE}$ to output delay	t _{CE}	—	100	—	120	—	150	ns	$\overline{OE} = V_{IL}$
$\overline{OE}$ to output delay	t _{OE}	—	60	—	60	—	70	ns	$\overline{CE} = V_{IL}$
$\overline{OE}$ high to output float ^{*1}	t _{DF}	0	35	0	40	0	50	ns	$\overline{CE} = V_{IL}$
Address to output hold	t _{OH}	5	—	5	—	5	—	ns	$\overline{CE} = \overline{OE} = V_{IL}$

Note: 1. t_{DF} is defined as the time at which the output achieves the open circuit condition and data is no longer driven.

Read Timing Waveform



Fast High-Reliability Page Programming

This device can be applied the high performance page programming algorithm shown in the following flowchart. This algorithm allows to obtain faster programming time without any voltage stress to the device nor deterioration in reliability of programmed data.

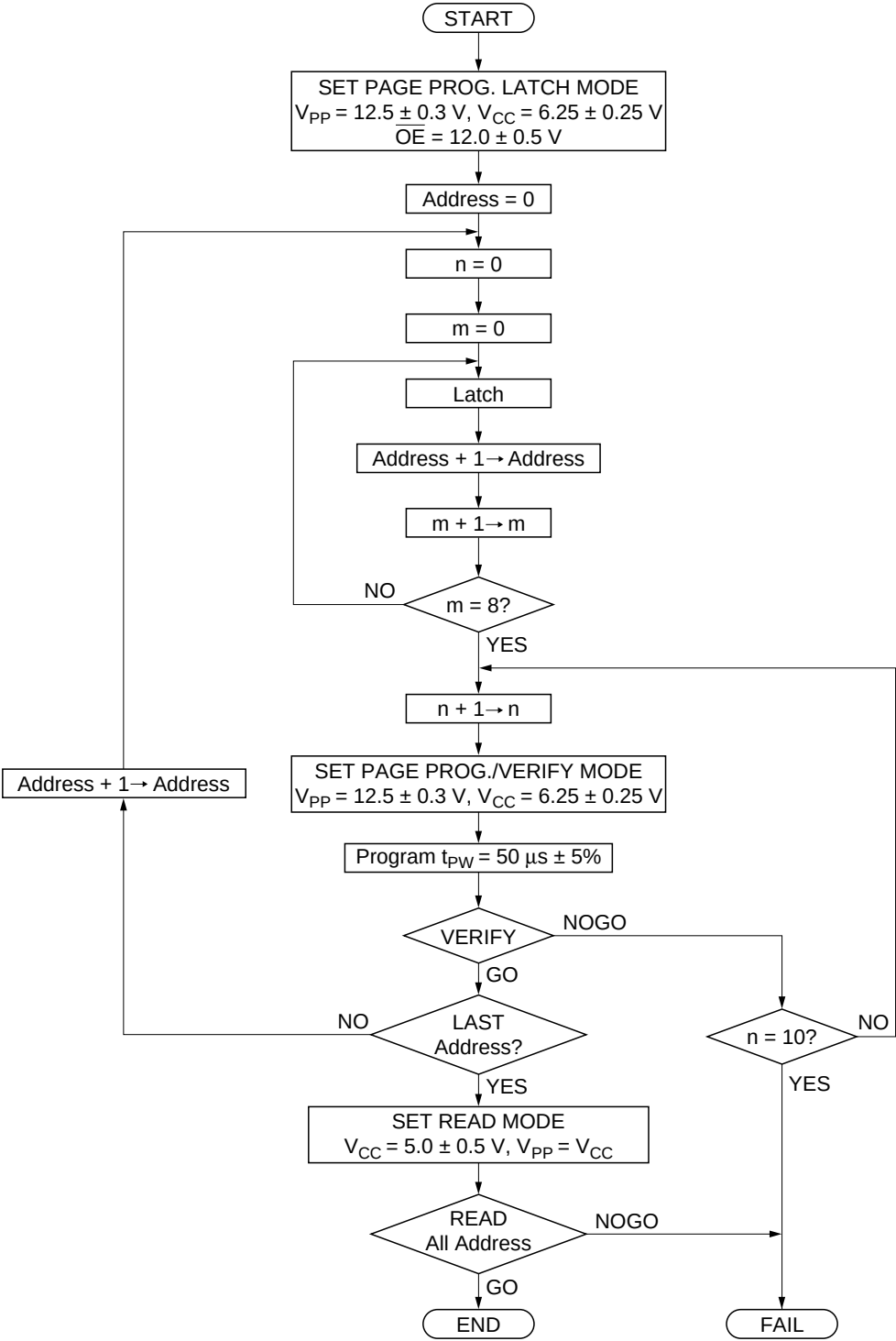
Page Program Set

Apply 12 V to $\overline{\text{OE}}$ pin after applying 12.5 V to V_{pp} to set a page program mode.

The device operates in a page program mode until reset.

Page Program Reset

Set V_{pp} to V_{CC} level or less to reset a page program mode.



Fast High-Reliability Page Programming Flowchart

DC Characteristics ($V_{CC} = 6.25\text{ V} \pm 0.25\text{ V}$, $V_{PP} = 12.5\text{ V} \pm 0.3\text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Input leakage current	I_{LI}	—	—	2	μA	$V_{in} = 6.5\text{ V} / 0.45\text{ V}$
Output voltage during verify	V_{OL}	—	—	0.45	V	$I_{OL} = 2.1\text{ mA}$
	V_{OH}	2.4	—	—	V	$I_{OH} = -400\text{ }\mu\text{A}$
Operating V_{CC} current	I_{CC}	—	—	50	mA	
Input voltage	V_{IL}	-0.1^{*5}	—	0.8	V	
	V_{IH}	2.2	—	$V_{CC} + 0.5^{*6}$	V	
	V_H	11.5	12.0	12.5	V	
V_{PP} supply current	I_{PP}	—	—	70	mA	$\overline{CE} = V_{IL}$

- Notes:
- 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP} .
 - 2. V_{PP} must not exceed 13.5 V including overshoot.
 - 3. An influence may be had upon device reliability if the device is installed or removed while $V_{PP} = 12.5\text{ V}$.
 - 4. Do not alter V_{PP} either V_{IL} to 12.5 V or 12.5 V to V_{IL} when $\overline{CE} = \text{low}$.
 - 5. $V_{IL\text{ min}} = -0.6\text{ V}$ for pulse width $\leq 20\text{ ns}$.
 - 6. If V_{IH} is over the specified maximum value, programming operation cannot be guaranteed.

AC Characteristics ($V_{CC} = 6.25\text{ V} \pm 0.25\text{ V}$, $V_{PP} = 12.5\text{ V} \pm 0.3\text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

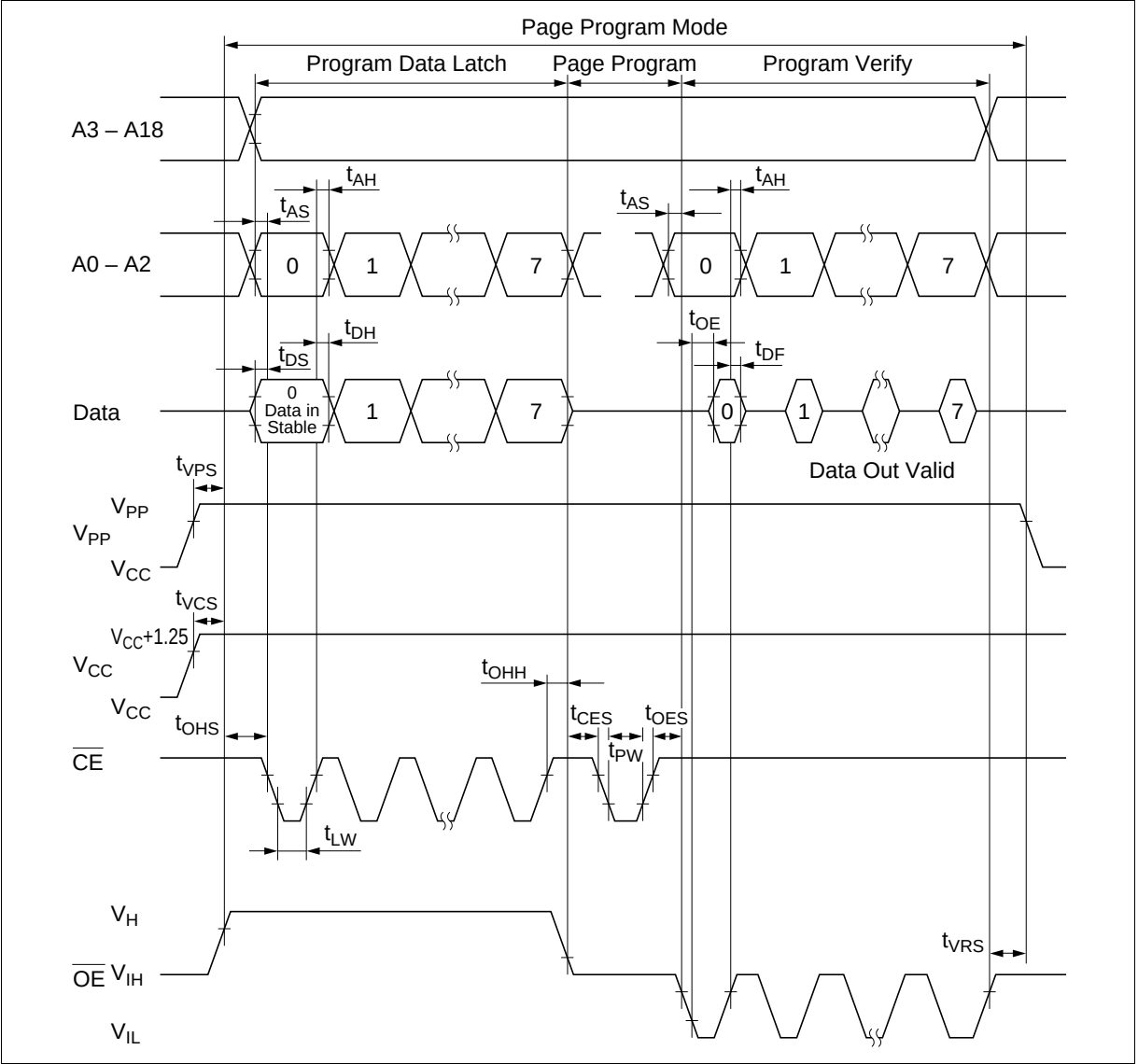
Test Conditions

- Input pulse levels: 0.45 to 2.4 V
- Input rise and fall time: $\leq 20\text{ ns}$
- Reference levels for measuring timing: Inputs: 0.8 V, 2.0 V
Outputs: 0.8 V, 2.0 V

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Address setup time	t_{AS}	2	—	—	μs	
$\overline{OE}$ setup time	t_{OES}	2	—	—	μs	
Data setup time	t_{DS}	2	—	—	μs	
Address hold time	t_{AH}	0	—	—	μs	
Data hold time	t_{DH}	2	—	—	μs	
$\overline{OE}$ high to output float delay	t_{DF}^{*1}	0	—	130	ns	
V_{PP} setup time	t_{VPS}	2	—	—	μs	
V_{CC} setup time	t_{VCS}	2	—	—	μs	
$\overline{CE}$ programming pulse width	t_{PW}	47.5	50.0	52.5	μs	
$\overline{CE}$ setup time	t_{CES}	2	—	—	μs	
Data valid from $\overline{OE}$	t_{OE}	0	—	150	ns	
$\overline{CE}$ pulse width during data latch	t_{LW}	1	—	—	μs	
$\overline{OE} = V_H$ setup time	t_{OHS}	2	—	—	μs	
$\overline{OE} = V_H$ hold time	t_{OHH}	2	—	—	μs	
V_{PP} hold time ^{*2}	t_{VRS}	1	—	—	μs	

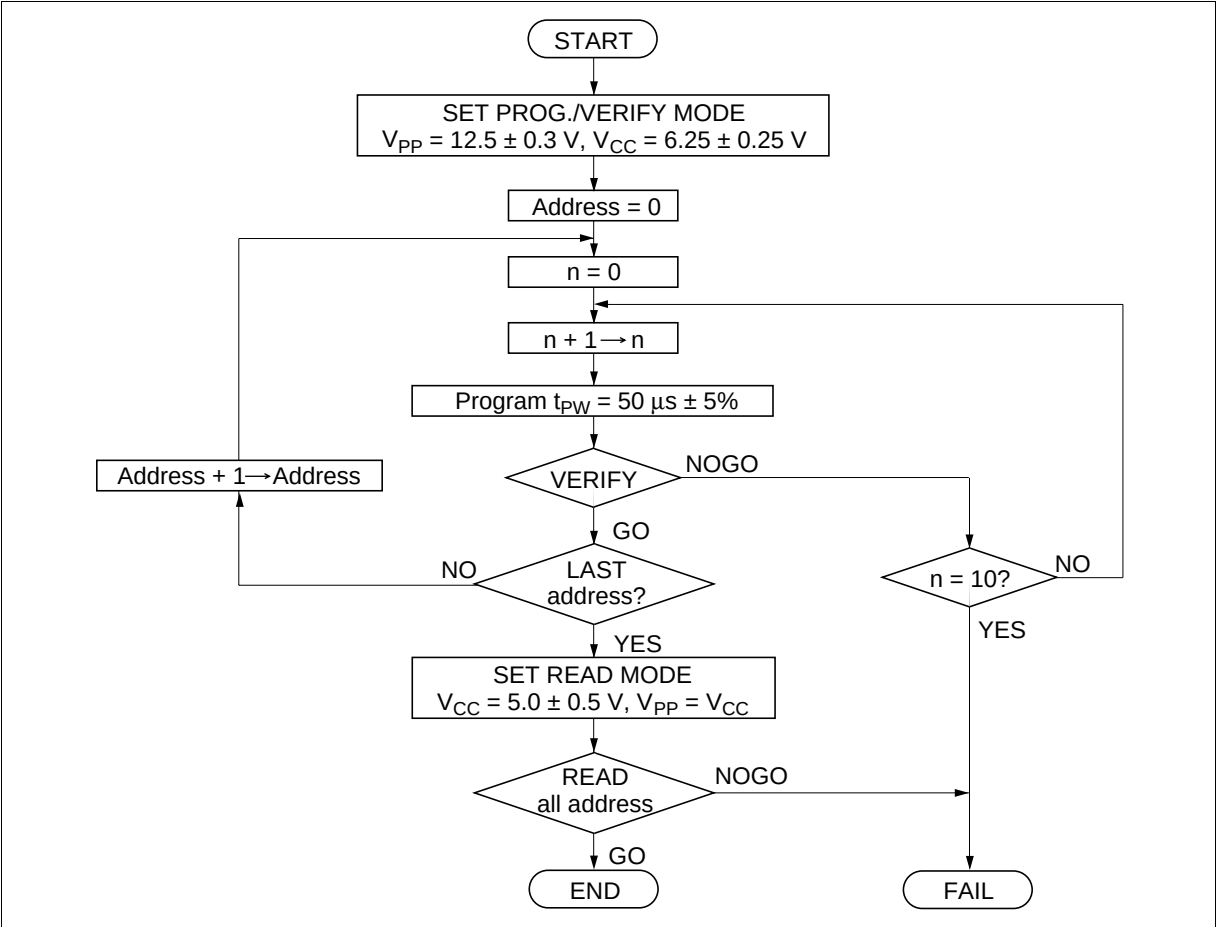
Notes: 1. t_{DF} is defined as the time at which the output achieves the open circuit conditions and data is no longer driven.
2. Page program mode will be reset when V_{PP} is set to V_{CC} or less.

Fast High-Reliability Page Programming Timing Waveform



Fast High-Reliability Programming

This device can be applied the fast high-reliability programming algorithm shown in the following flowchart. This algorithm allows to obtain faster programming time without any voltage stress to the device nor deterioration in reliability of programmed data.



Fast High-Reliability Programming Flowchart

DC Characteristics ($V_{CC} = 6.25\text{ V} \pm 0.25\text{ V}$, $V_{PP} = 12.5\text{ V} \pm 0.3\text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Input leakage current	I_{LI}	—	—	2	μA	$V_{in} = 6.5\text{ V} / 0.45\text{ V}$
V_{PP} supply current	I_{PP}	—	—	40	mA	$\overline{CE} = V_{IL}$
Operating V_{CC} current	I_{CC}	—	—	50	mA	
Input voltage	V_{IL}	-0.1^{*5}	—	0.8	V	
	V_{IH}	2.2	—	$V_{CC} + 0.5^{*6}\text{ V}$	V	
Output voltage	V_{OL}	—	—	0.45	V	$I_{OL} = 2.1\text{ mA}$
	V_{OH}	2.4	—	—	V	$I_{OH} = -400\text{ }\mu\text{A}$

- Notes: 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP} .
2. V_{PP} must not exceed 13.5 V including overshoot.
3. An influence may be had upon device reliability if the device is installed or removed while $V_{PP} = 12.5\text{ V}$.
4. Do not alter V_{PP} either V_{IL} to 12.5 V or 12.5 V to V_{IL} when $\overline{CE} = \text{low}$.
5. $V_{IL}\text{ min} = -0.6\text{ V}$ for pulse width $\leq 20\text{ ns}$.
6. If V_{IH} is over the specified maximum value, programming operation cannot be guaranteed.

AC Characteristics ($V_{CC} = 6.25\text{ V} \pm 0.25\text{ V}$, $V_{PP} = 12.5\text{ V} \pm 0.3\text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

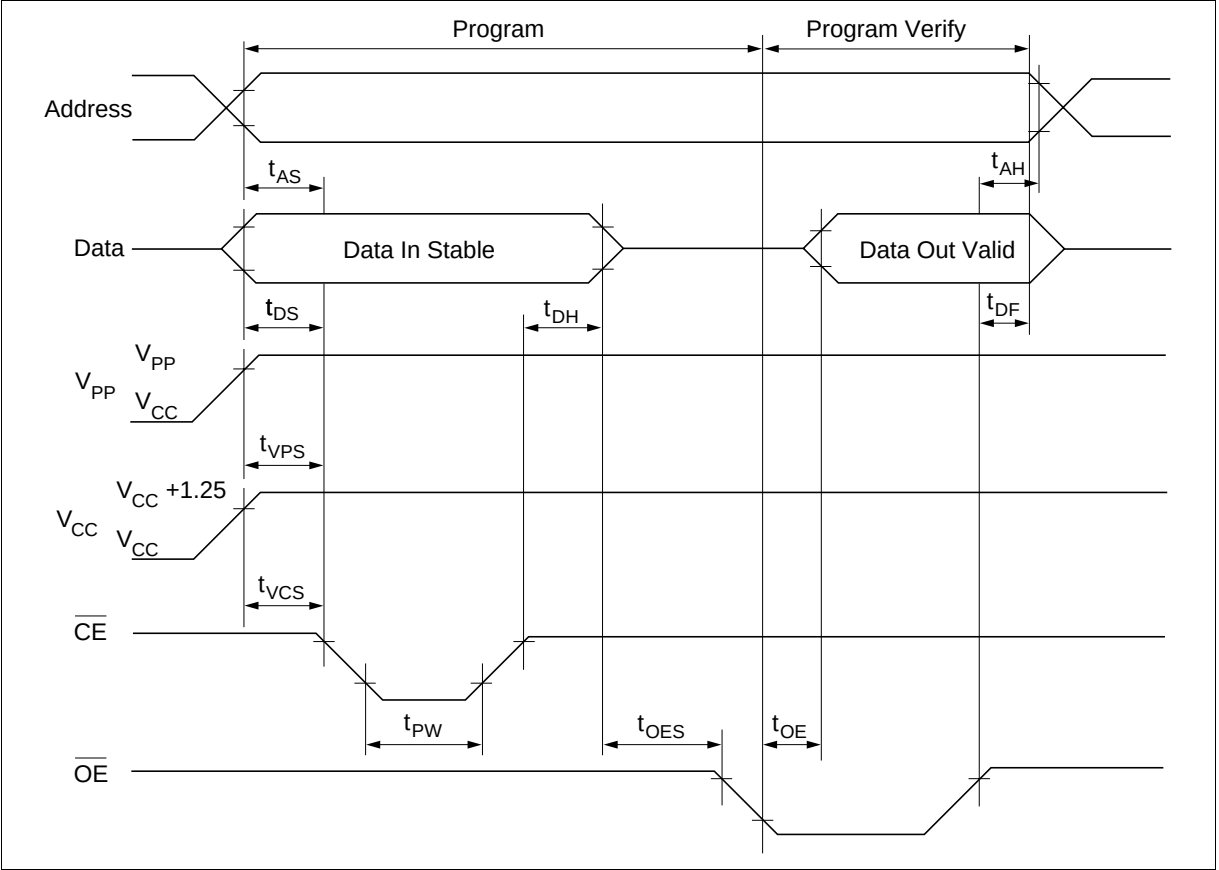
Test Conditions

- Input pulse levels: 0.45 to 2.4 V
- Input rise and fall time: $\leq 20\text{ ns}$
- Reference levels for measuring timing: Inputs: 0.8 V, 2.0 V
Outputs: 0.8 V, 2.0 V

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Address setup time	t_{AS}	2	—	—	μs	
$\overline{OE}$ setup time	t_{OES}	2	—	—	μs	
Data setup time	t_{DS}	2	—	—	μs	
Address hold time	t_{AH}	0	—	—	μs	
Data hold time	t_{DH}	2	—	—	μs	
$\overline{OE}$ to output float delay	t_{DF}^{*1}	0	—	130	ns	
V_{PP} setup time	t_{VPS}	2	—	—	μs	
V_{CC} setup time	t_{VCS}	2	—	—	μs	
$\overline{CE}$ programming pulse width	t_{PW}	47.5	50.0	52.5	μs	
Data valid from $\overline{OE}$	t_{OE}	0	—	150	ns	

Note: 1. t_{DF} is defined as the time at which the output achieves the open circuit condition and data is no longer driven.

Fast High-Reliability Programming Timing Waveform

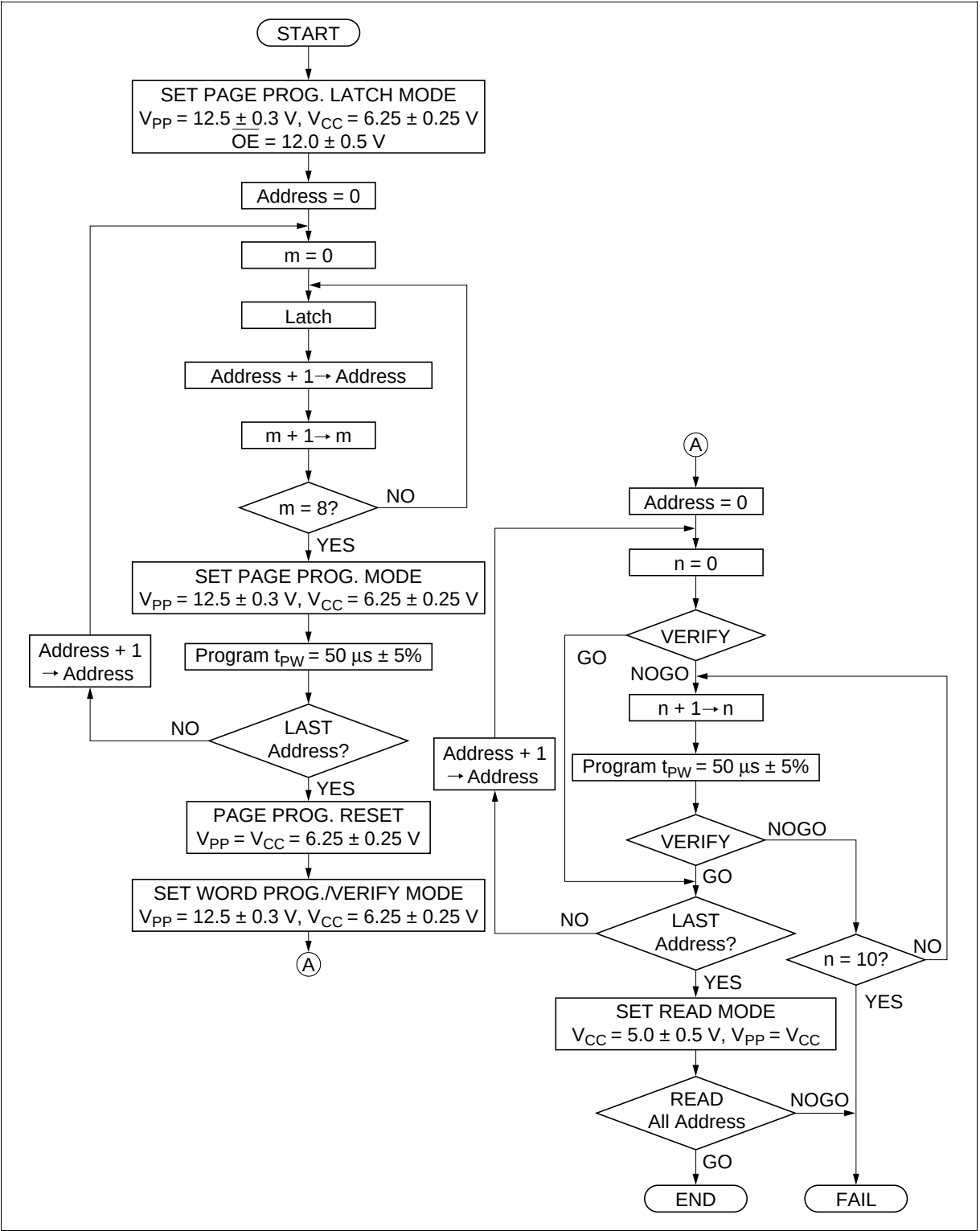


Optional Page Programming

This device can be applied the optional page programming algorithm shown in the following flowchart. This algorithm allows to obtain faster programming time without any voltage stress to the device nor deterioration in reliability of programmed data.

This programming algorithm is the combination of page programming and byte verify. It can avoid the increase of programming verify time when a programmer with slow machine cycle is used, and shorten the total programming time.

Regarding the timing specifications for page programming and byte verify, please refer to the specifications for fast high-reliability page programming and fast high-reliability programming.



Optional Page Programming Flowchart

DC Characteristics ($V_{CC} = 6.25\text{ V} \pm 0.25\text{ V}$, $V_{PP} = 12.5\text{ V} \pm 0.3\text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Input leakage current	I_{LI}	—	—	2	μA	$V_{in} = 6.5\text{ V} / 0.45\text{ V}$
Output voltage during verify	V_{OL}	—	—	0.45	V	$I_{OL} = 2.1\text{ mA}$
	V_{OH}	2.4	—	—	V	$I_{OH} = -400\text{ }\mu\text{A}$
Operating V_{CC} current	I_{CC}	—	—	50	mA	
Input voltage	V_{IL}	-0.1^{*5}	—	0.8	V	
	V_{IH}	2.2	—	$V_{CC} + 0.5^{*6}$	V	
	V_H	11.5	12.0	12.5	V	
Vpp supply current	I_{PP}	—	—	70	mA	$\overline{CE} = V_{IL}$

- Notes:
- 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP} .
 - 2. V_{PP} must not exceed 13.5 V including overshoot.
 - 3. An influence may be had upon device reliability if the device is installed or removed while $V_{PP} = 12.5\text{ V}$.
 - 4. Do not alter V_{PP} either V_{IL} to 12.5 V or 12.5 V to V_{IL} when $\overline{CE} = \text{low}$.
 - 5. $V_{IL\text{ min}} = -0.6\text{ V}$ for pulse width $\leq 20\text{ ns}$.
 - 6. If V_{IH} is over the specified maximum value, programming operation cannot be guaranteed.

AC Characteristics ($V_{CC} = 6.25\text{ V} \pm 0.25\text{ V}$, $V_{PP} = 12.5\text{ V} \pm 0.3\text{ V}$, $T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)

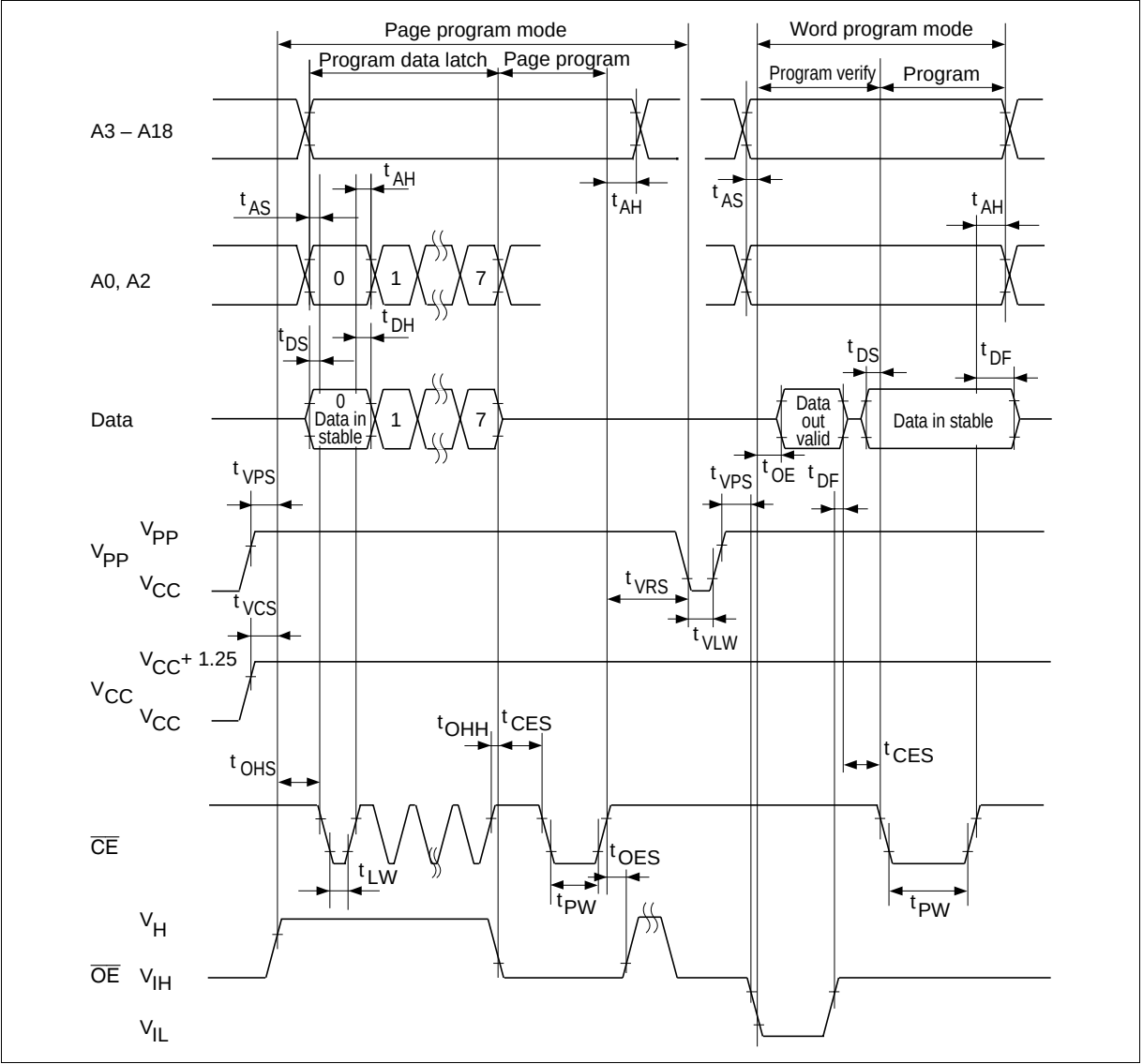
Test Conditions

- Input pulse levels: 0.45 to 2.4 V
- Input rise and fall time: $\leq 20\text{ ns}$
- Reference levels for measuring timing: Inputs: 0.8 V, 2.0 V
Outputs: 0.8 V, 2.0 V

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Address setup time	t_{AS}	2	—	—	μs	
$\overline{OE}$ setup time	t_{OES}	2	—	—	μs	
Data setup time	t_{DS}	2	—	—	μs	
Address hold time	t_{AH}	0	—	—	μs	
Data hold time	t_{DH}	2	—	—	μs	
$\overline{OE}$ high to output float delay	t_{DF}^{*1}	0	—	130	ns	
V_{PP} setup time	t_{VPS}	2	—	—	μs	
V_{CC} setup time	t_{VCS}	2	—	—	μs	
$\overline{CE}$ programming pulse width	t_{PW}	47.5	50.0	52.5	μs	
$\overline{CE}$ setup time	t_{CES}	2	—	—	μs	
Data valid from $\overline{OE}$	t_{OE}	0	—	150	ns	
$\overline{CE}$ pulse width during data latch	t_{LW}	1	—	—	μs	
$\overline{OE} = V_H$ setup time	t_{OHS}	2	—	—	μs	
$\overline{OE} = V_H$ hold time	t_{OHH}	2	—	—	μs	
Page programming reset time ^{*2}	t_{VLW}	1	—	—	μs	
V_{PP} hold time ^{*2}	t_{VRS}	1	—	—	μs	

Notes: 1. t_{DF} is defined as the time at which the output achieves the open circuit condition and data is no longer driven.
2. Page program mode will be reset when V_{PP} is set to V_{CC} or less.

Option Page Programming Timing Waveform



Erase

Erasure of HN27C4001G is performed by exposure to ultraviolet light of 2537 Å and all the output data are changed to “1” after this erasure procedure. The minimum integrated dose (i.e. UV intensity x exposure time) for erasure is 15 W· sec/cm².

HN27C4001G Series

Mode Description

Device Identifier Mode

The device identifier mode allows the reading out of binary codes that identify manufacturer and type of device, from outputs of EPROM. By this mode, the device will be automatically matched its own corresponding programming algorithm, using programming equipment.

HN27C4001G Identifier Code

Identifier	A0 (12)	I/O7 (21)	I/O6 (20)	I/O5 (19)	I/O4 (18)	I/O (17)	I/O2 (15)	I/O1 (14)	I/O0 (13)	Hex Data
Manufacturer code	V _{IL}	0	0	0	0	0	1	1	1	07
Device code	V _{IH}	0	0	1	0	0	0	0	0	20

- Notes:
- 1. $V_{CC} = 5.0\text{ V} \pm 10\%$
 - 2. $A_9 = 12.0\text{ V} \pm 0.5\text{ V}$
 - 3. $\overline{CE}, \overline{OE} = V_{IL}$
 - 4. A1 – A8, A10 – A18: Don't care.

Package Dimensions

HN27C4001G Series (DG-32A)

Unit: mm

